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PATENTS ONLY

U.S. DEPARTMENT OF COMMERCE
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Attorney Docket : 033773 M 220

1. Name of conveying party(ies):
Keiichi KAJIYAMA
Tadato NAGASAWA
Additional name of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: Disco Corporation
Street Address: 13-11, Omori-Kita 2-chome, Ota-ku
Tokyo 143-8580, JAPAN
Additional Name(s) & address(es) attached? Yes No

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: April 23, 2007

4. Application number(s) or patent number(s): This document is being filed together with a new application.
A. Patent Application No.(s)
B. Patent No.(s)
Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning this document should be mailed:
Name: Michael A. Makuch
Internal Address: SMITH, GAMBRELL & RUSSELL, LLP
Street Address: 1850 M Street, NW - Suite 800
City: Washington State: DC Zip: 20036

6. Total number of applications and patents involved: - 1 -
7. Total fee (37 CFR 3.41) \$40.00
 Enclosed
 Authorized to be charged to deposit account
8. Deposit account number:
02-4300
(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Michael A. Makuch
Name of Person Signing

Signature
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04 FC:0021
May 7, 2007
Date
40.00

Total number of pages including cover sheet, attachments, and documents: - 2 -
Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments, Washington, D.C. 20231

236590

PATENT
REEL: 019343 FRAME: 0145

Assignment

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned, Keiichi KAJIYAMA and Tadato NAGASAWA, all citizen of Japan, residing respectively at Tokyo, Japan and Tokyo, Japan.


Hereby sell, assign and transfer to Disco Corporation a corporation of Japan having a place of business at 13-11, Omori-Kita 2-chome, Ota-ku, Tokyo 143-8580 Japan its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith April 23, 2007, and is entitled WAFER PROCESSING METHOD

, and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: April 23, 2007

 (L.S.)

T. Nagasawa (L.S.)

..... (L.S.)


..... (L.S.)

..... (L.S.)

..... (L.S.)

..... (L.S.)

Witness



PATENT

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